



FIG. 1

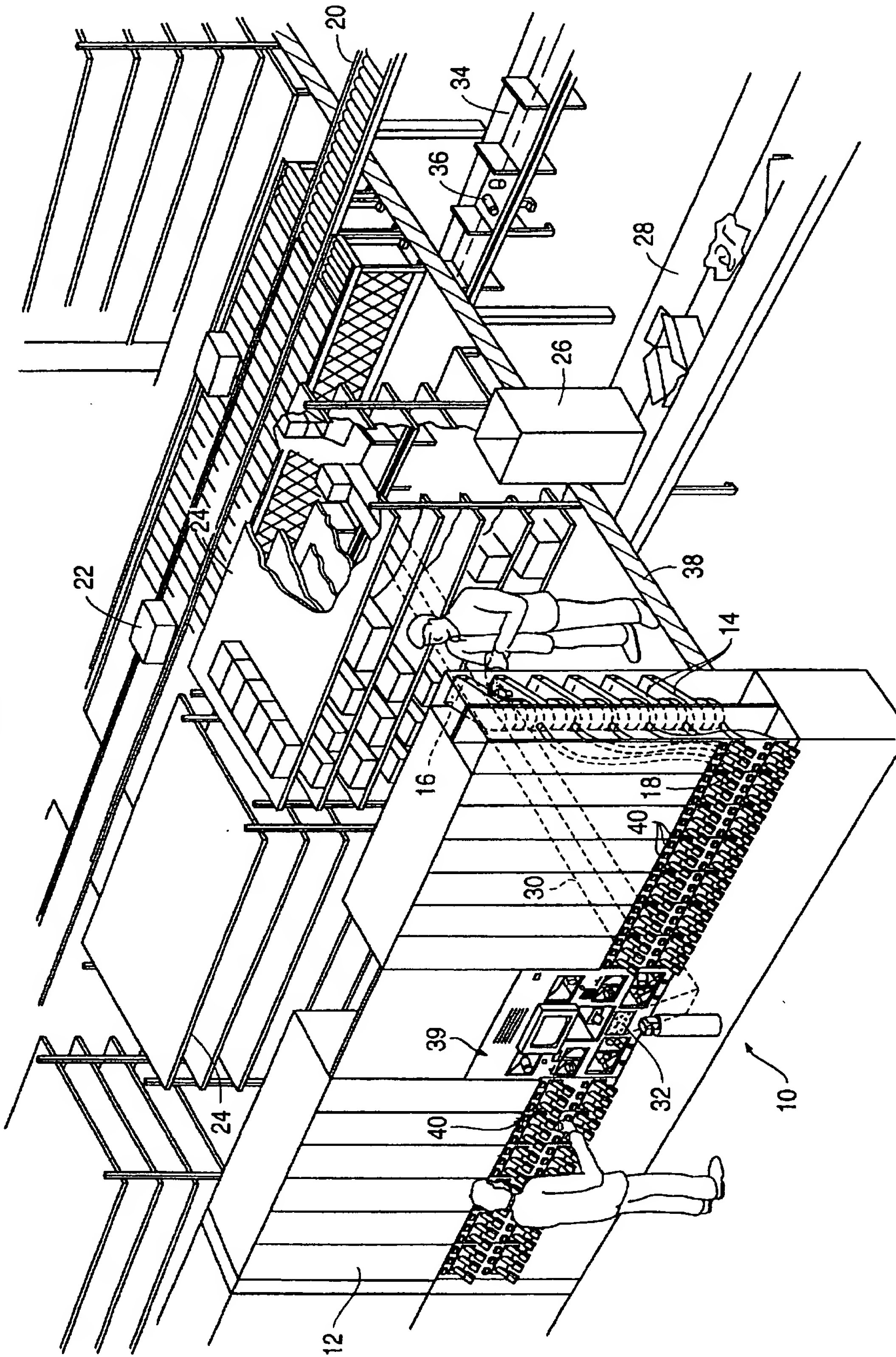




FIG. 2

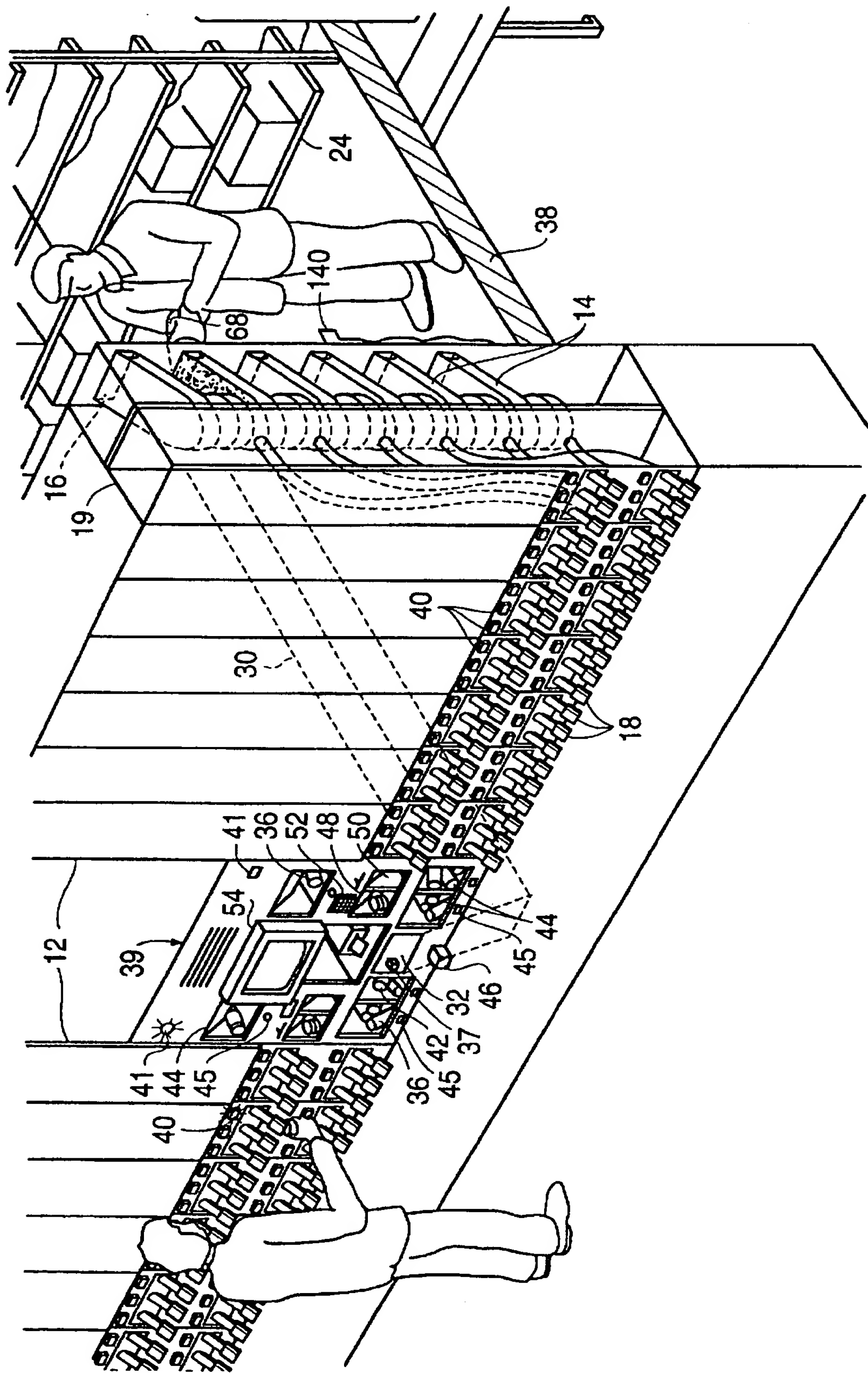
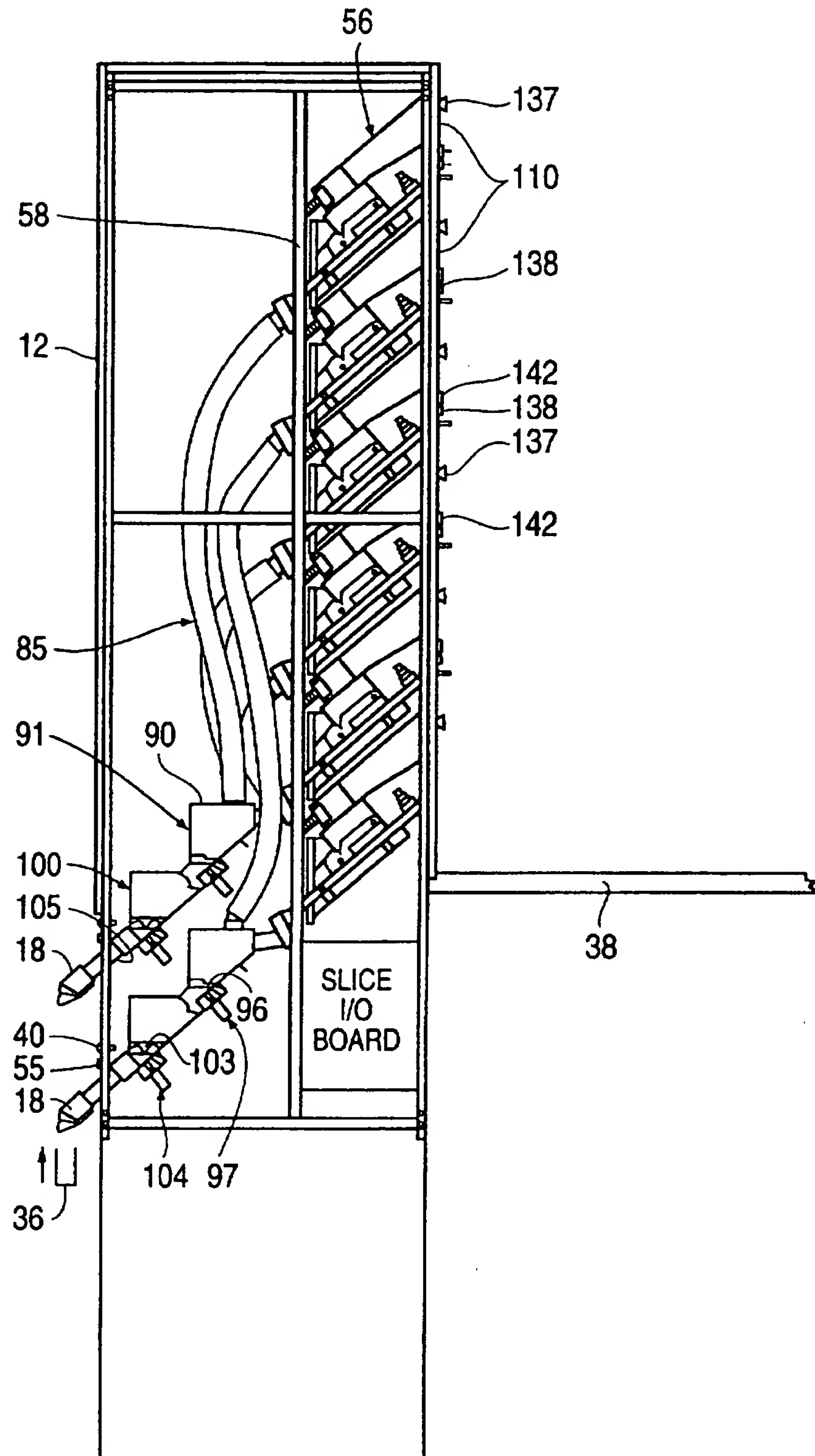
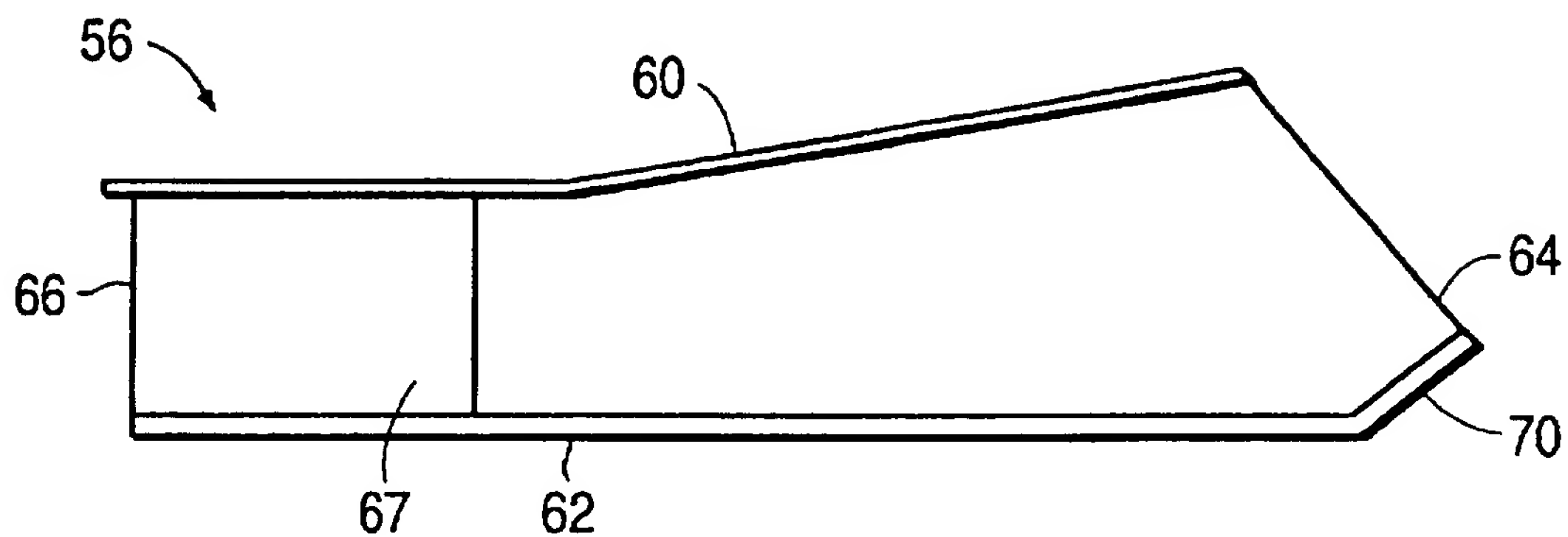


FIG. 3

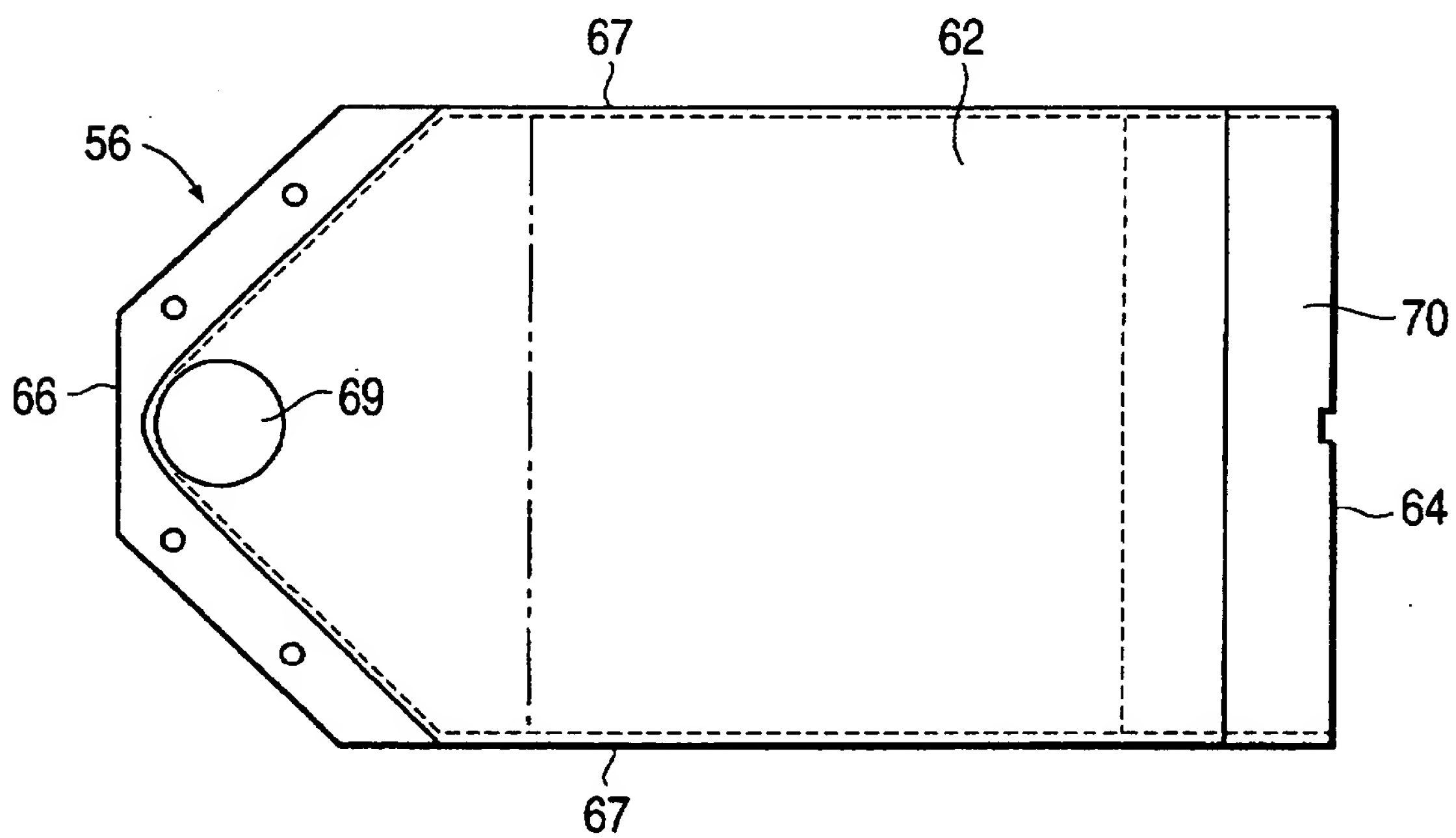




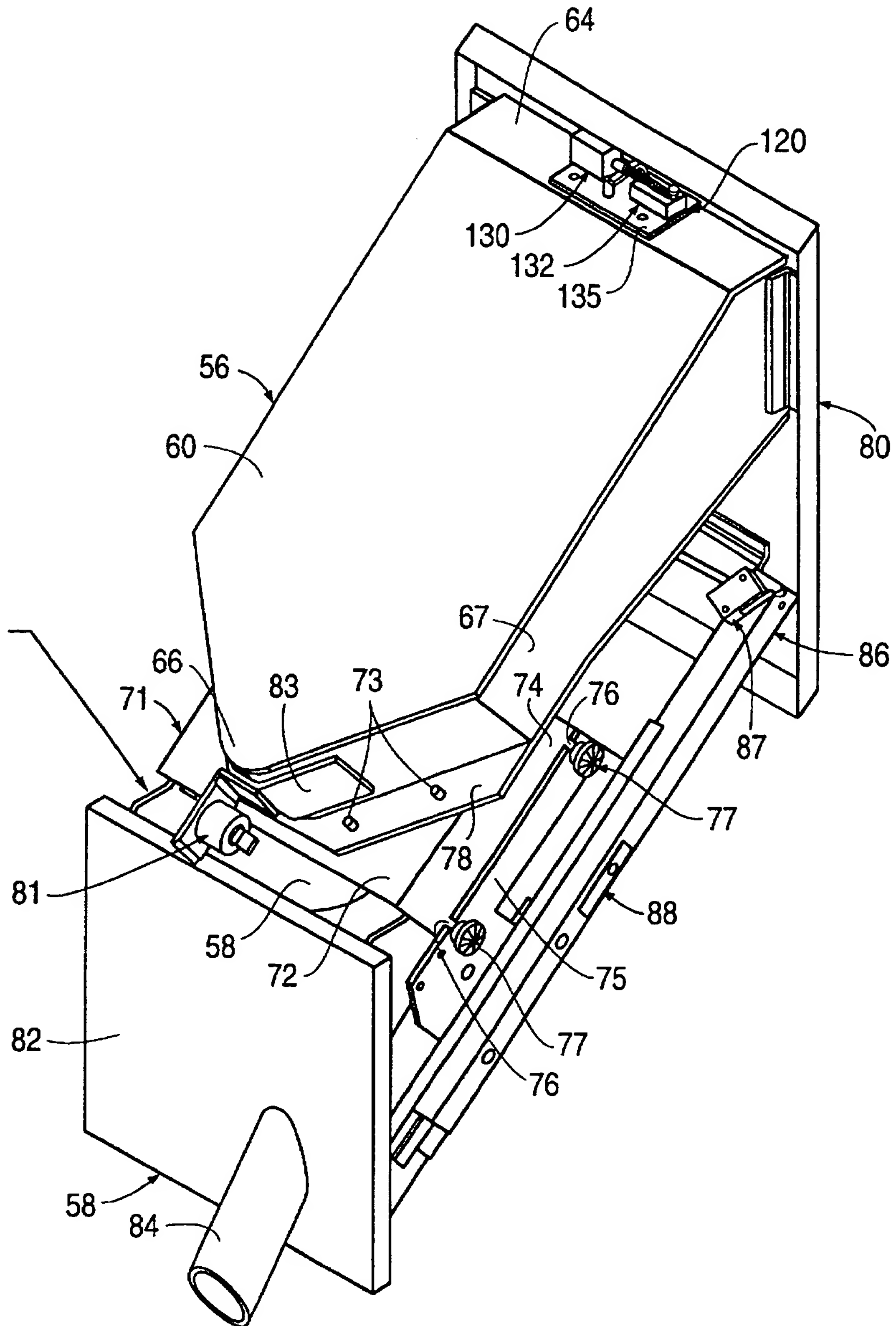
**FIG. 4**



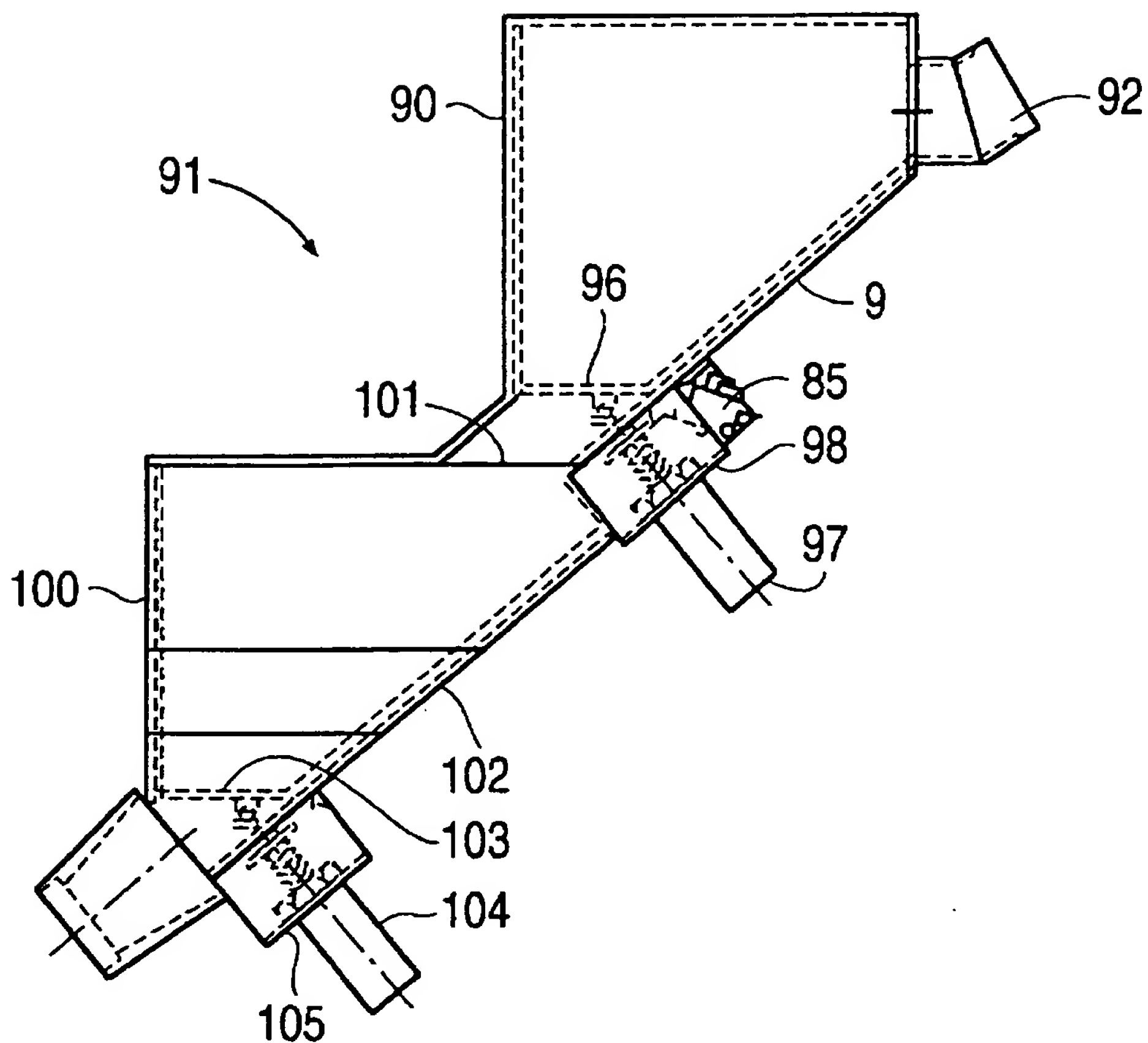
**FIG. 5**



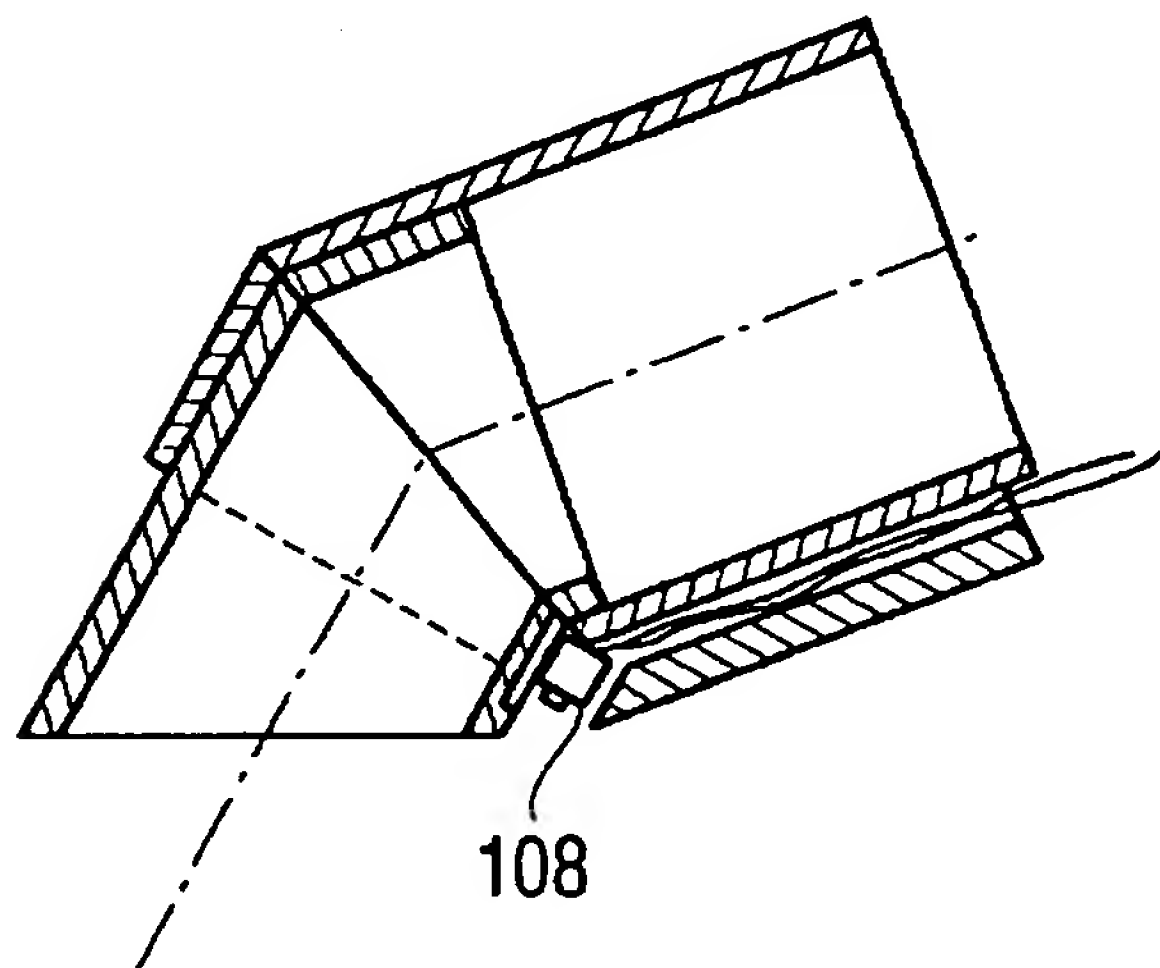
**FIG. 6**



**FIG. 7**

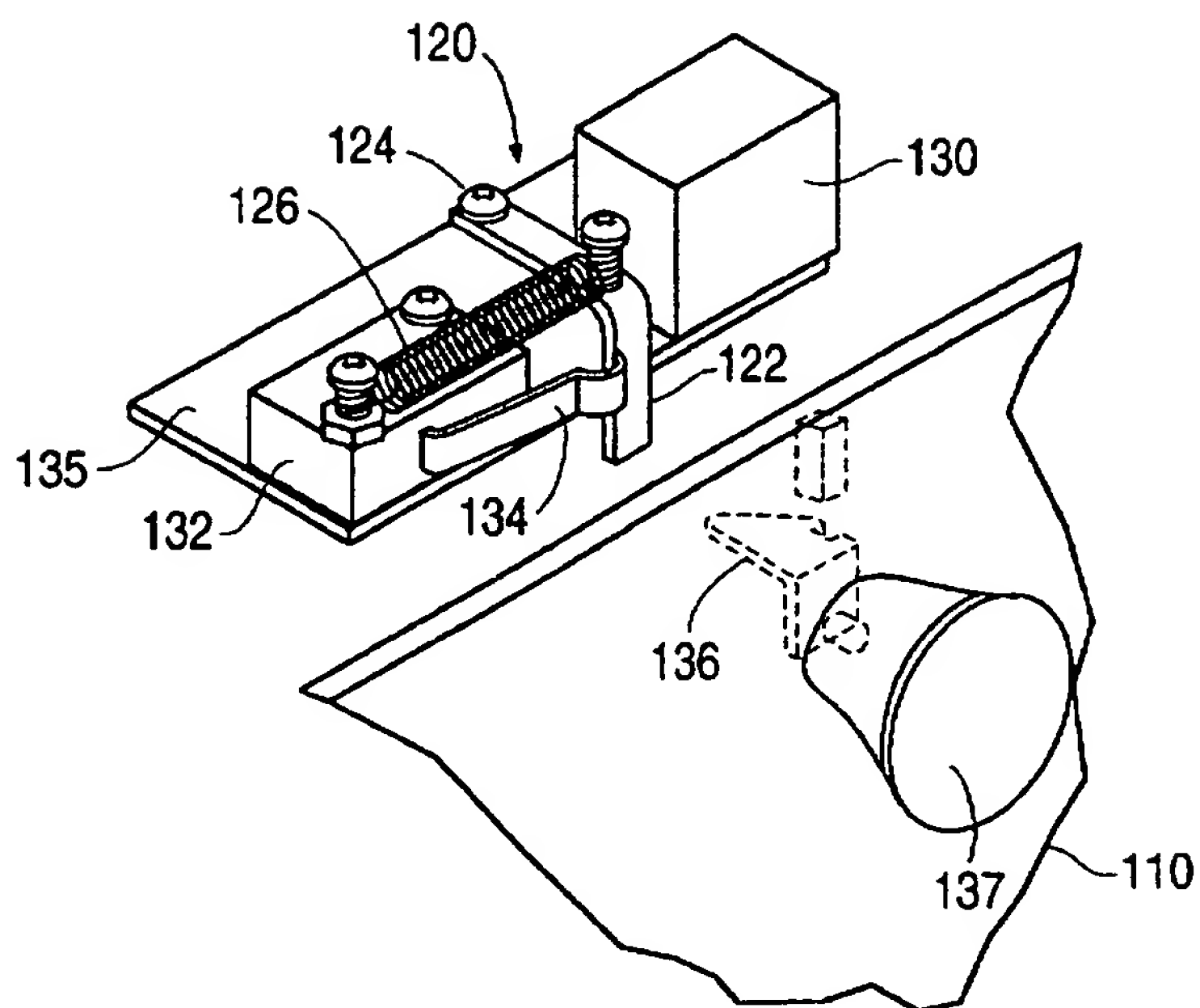


**FIG. 8**

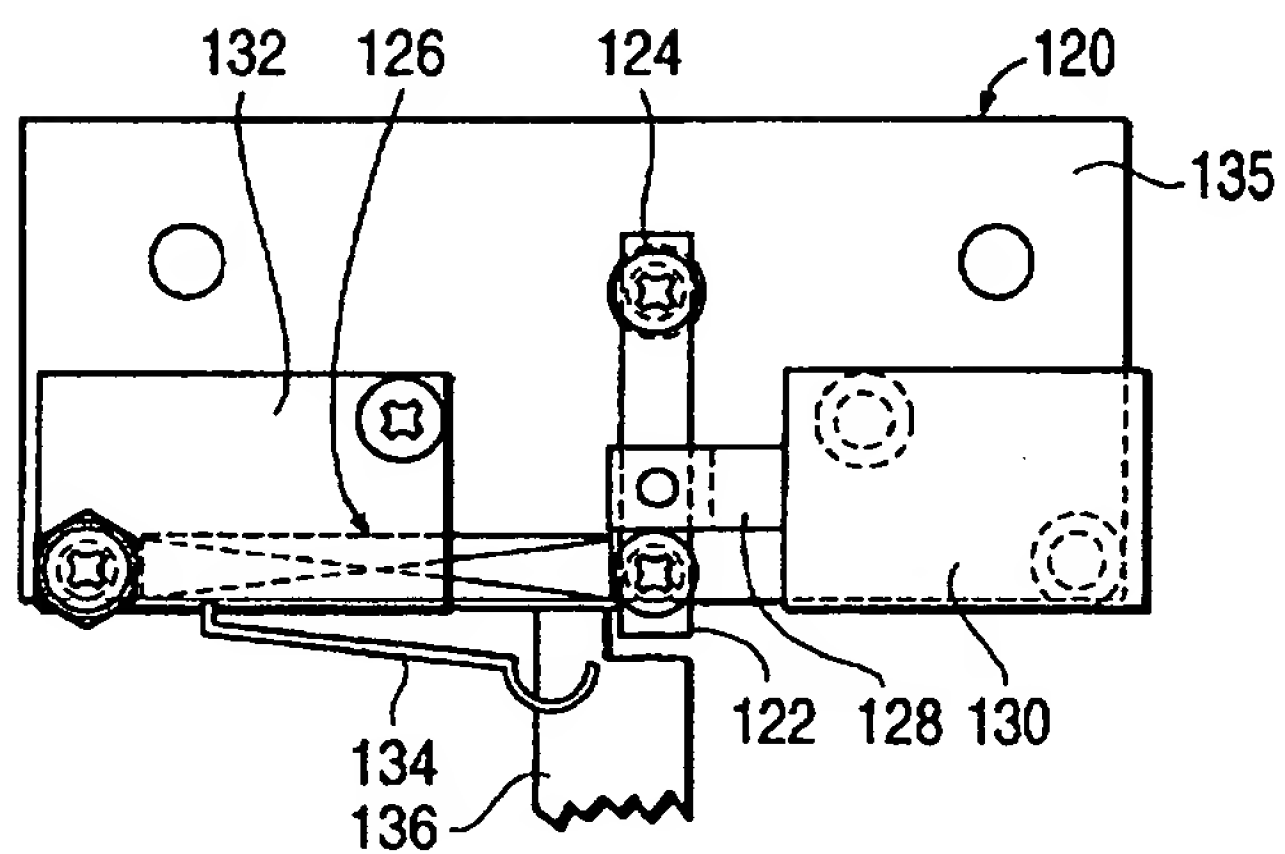




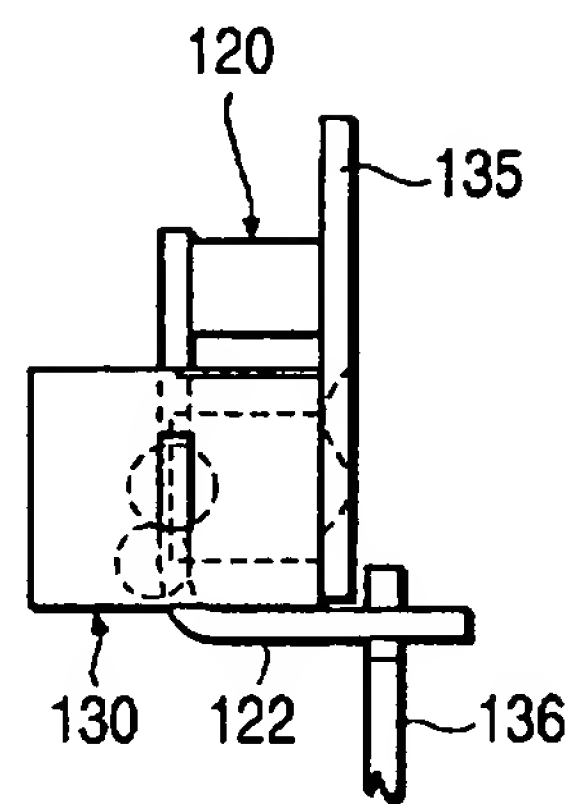
**FIG. 9**



**FIG. 10**



**FIG. 11**



**FIG. 12**

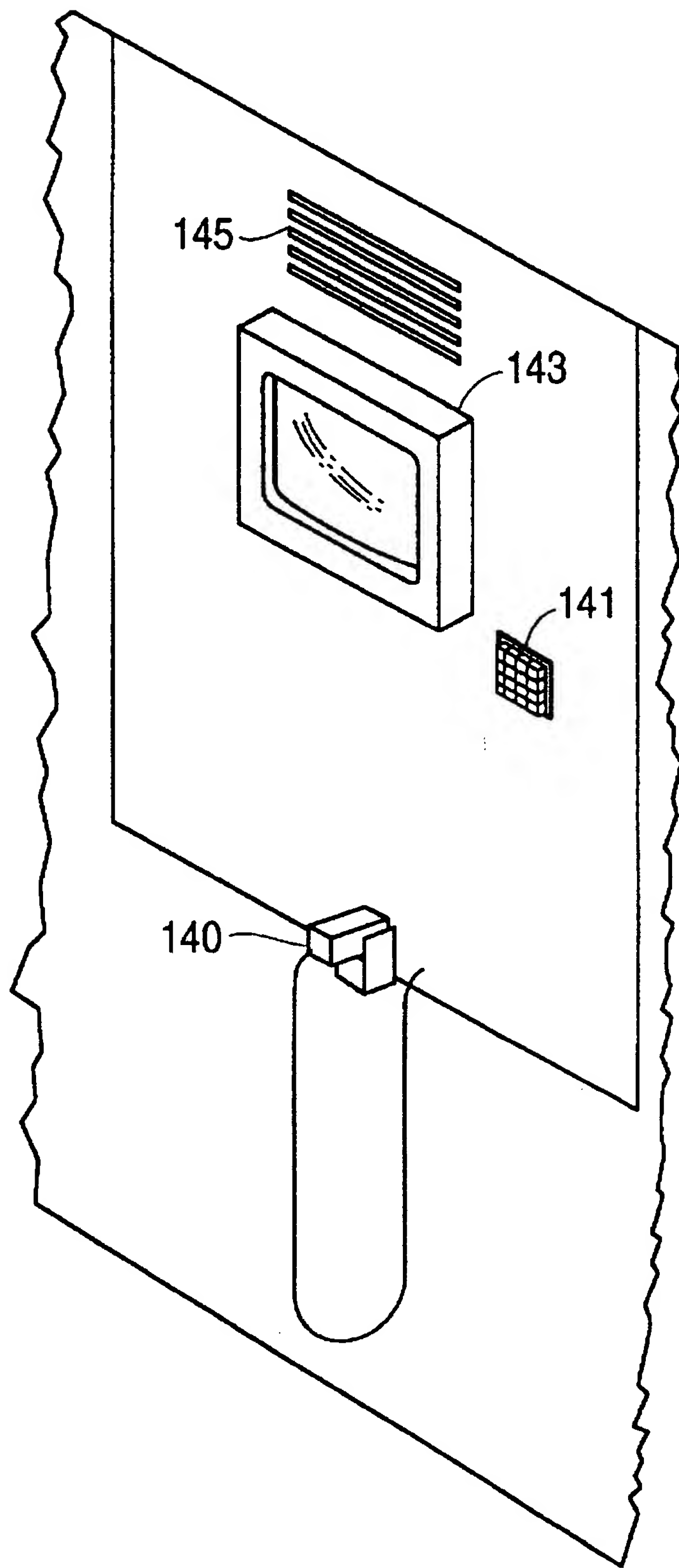






FIG. 13

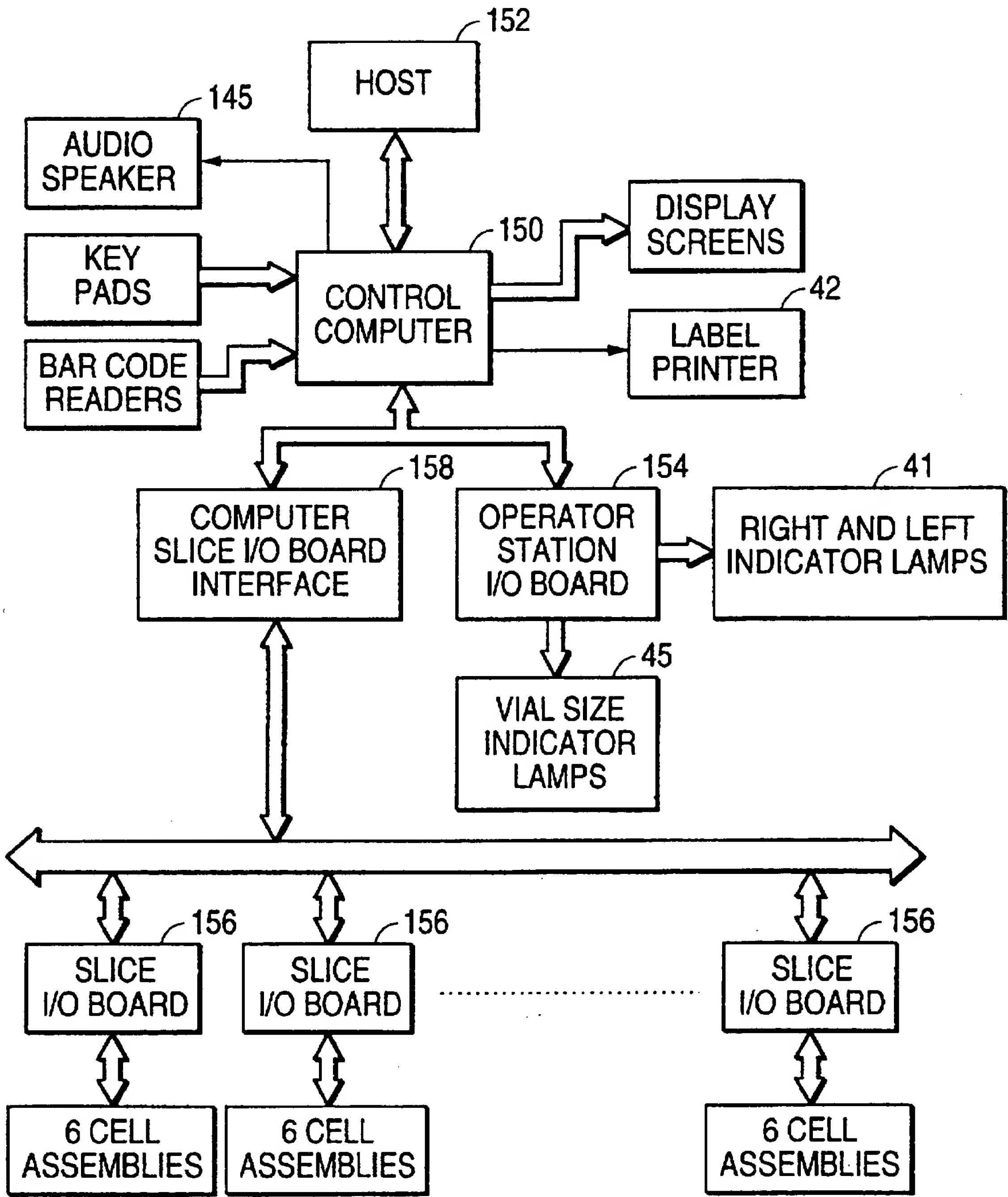




FIG. 14

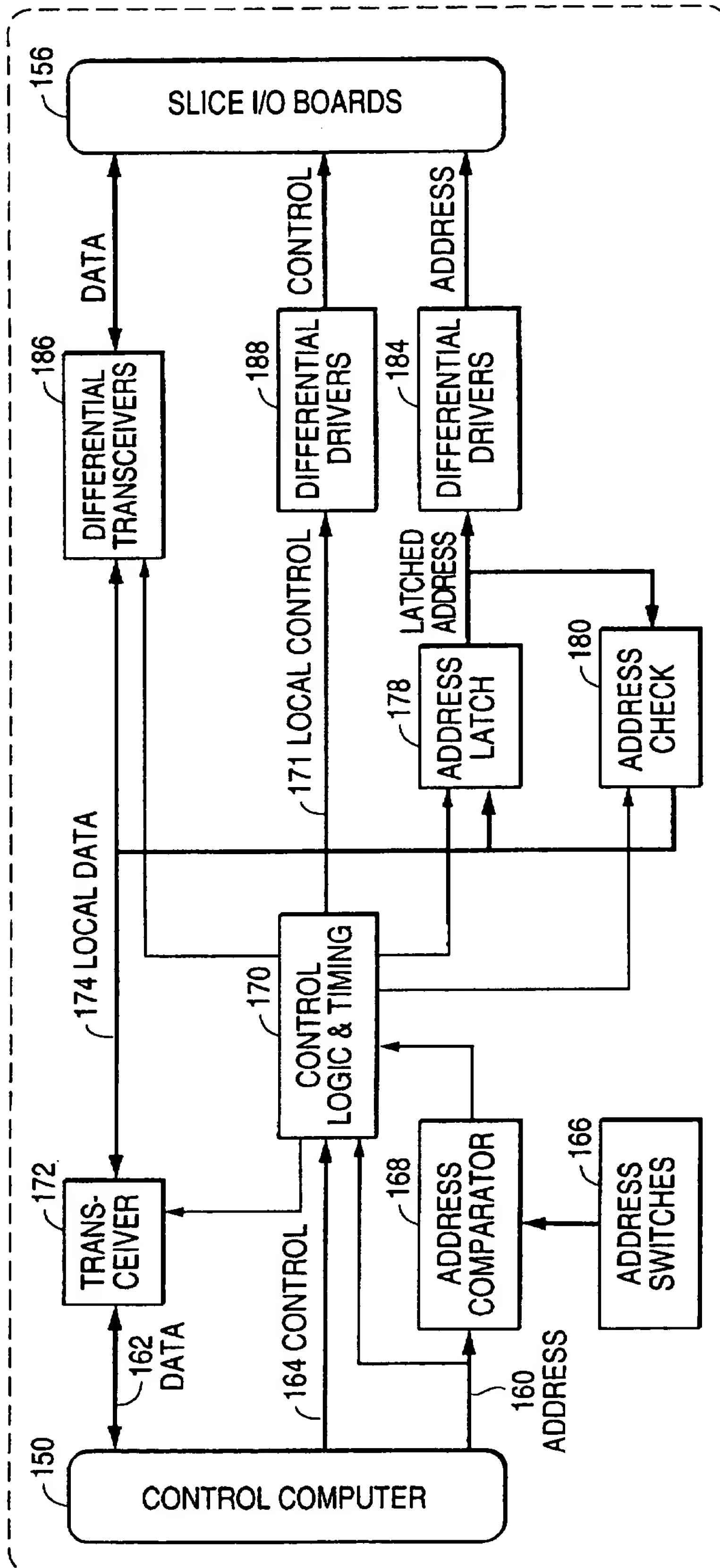
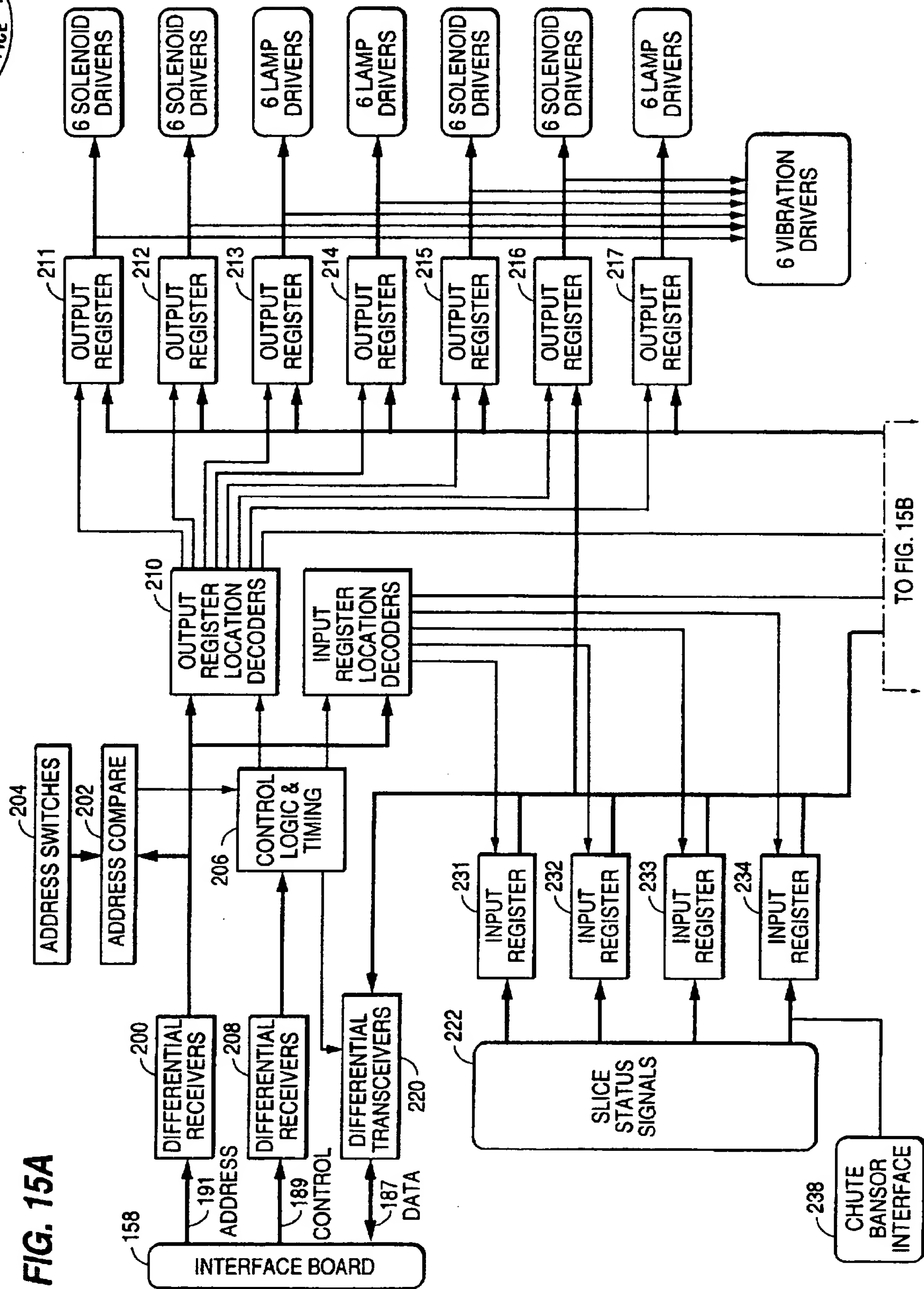




FIG. 15A



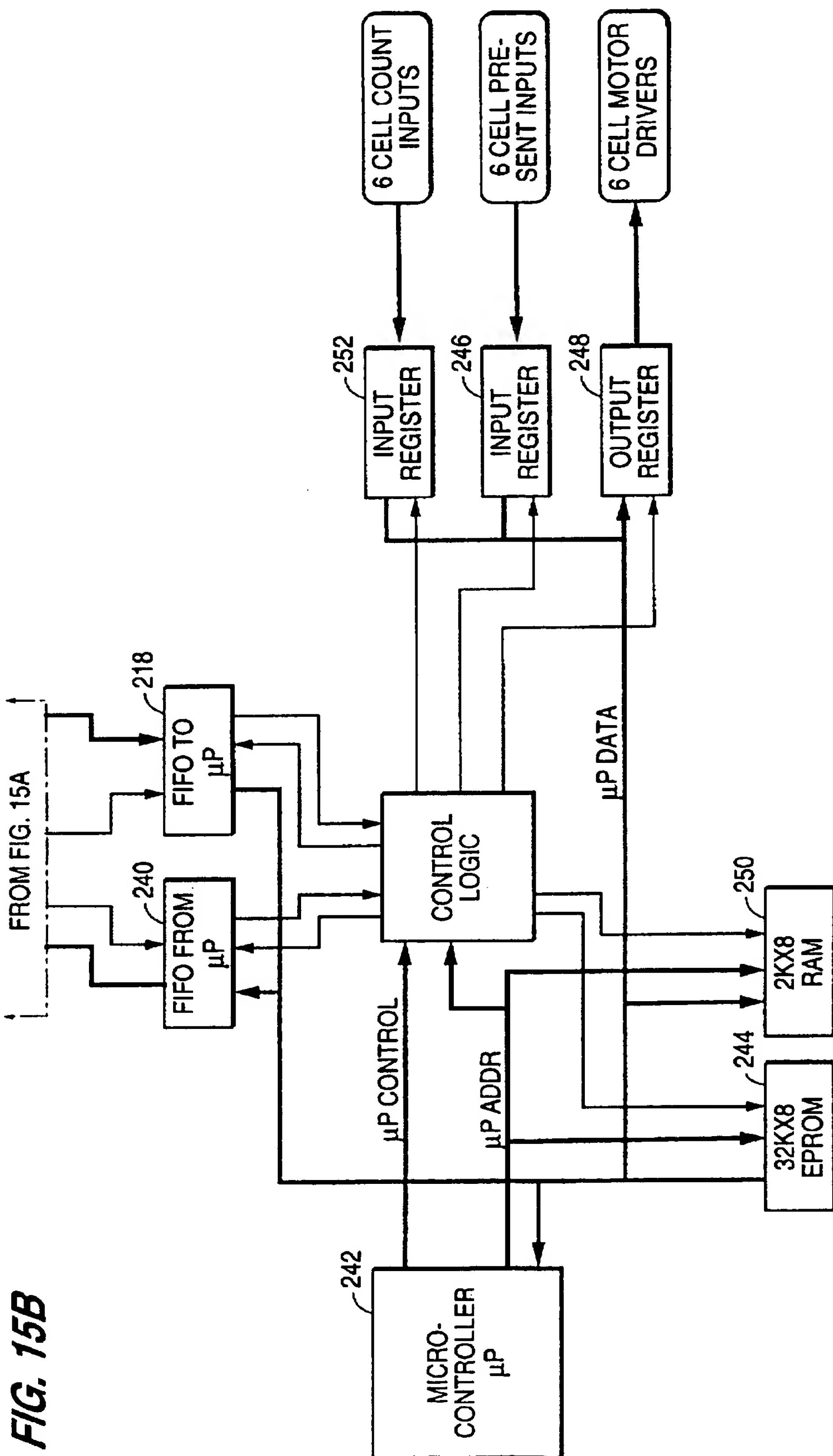
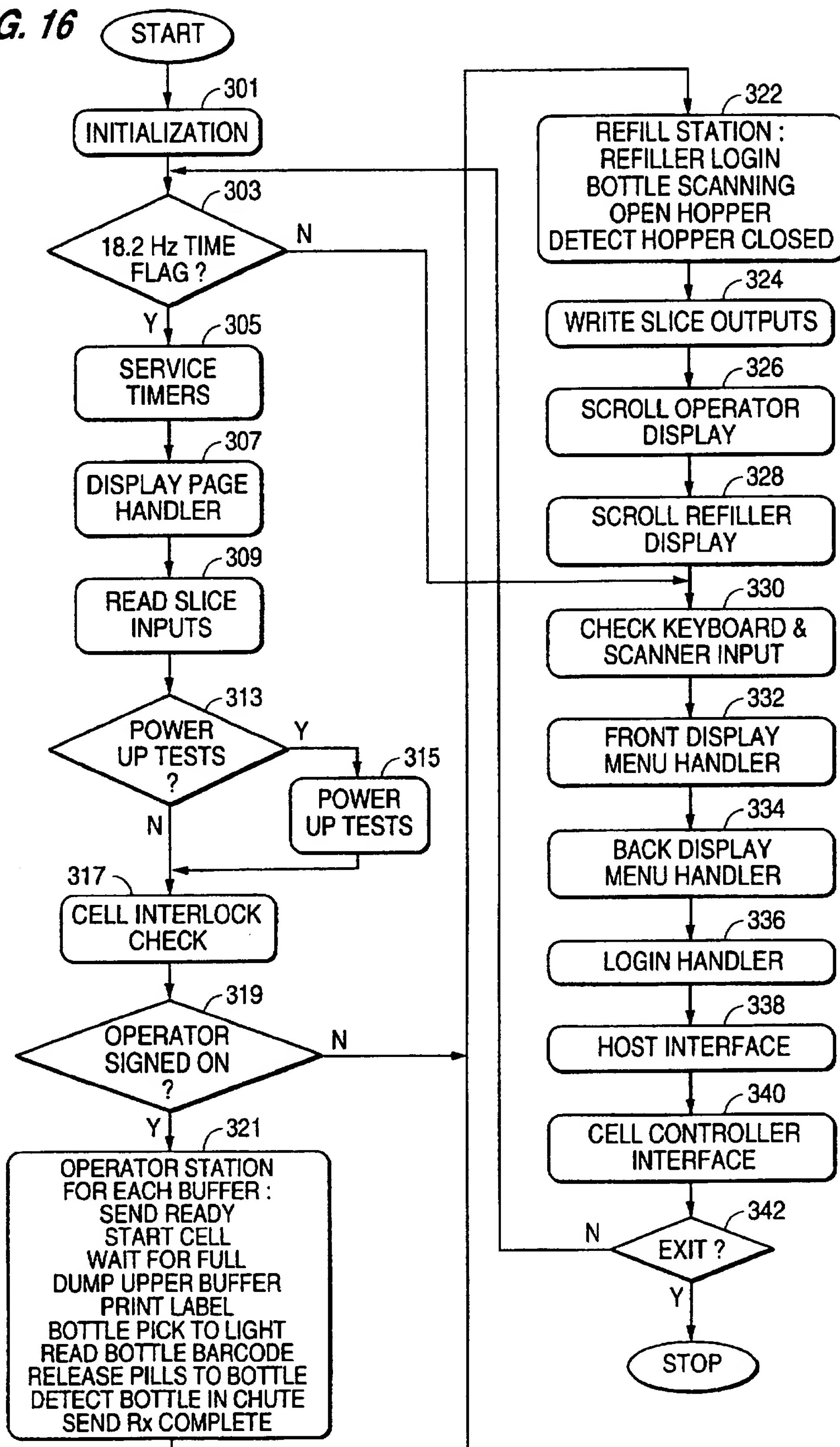


FIG. 16



**FIG. 17A**

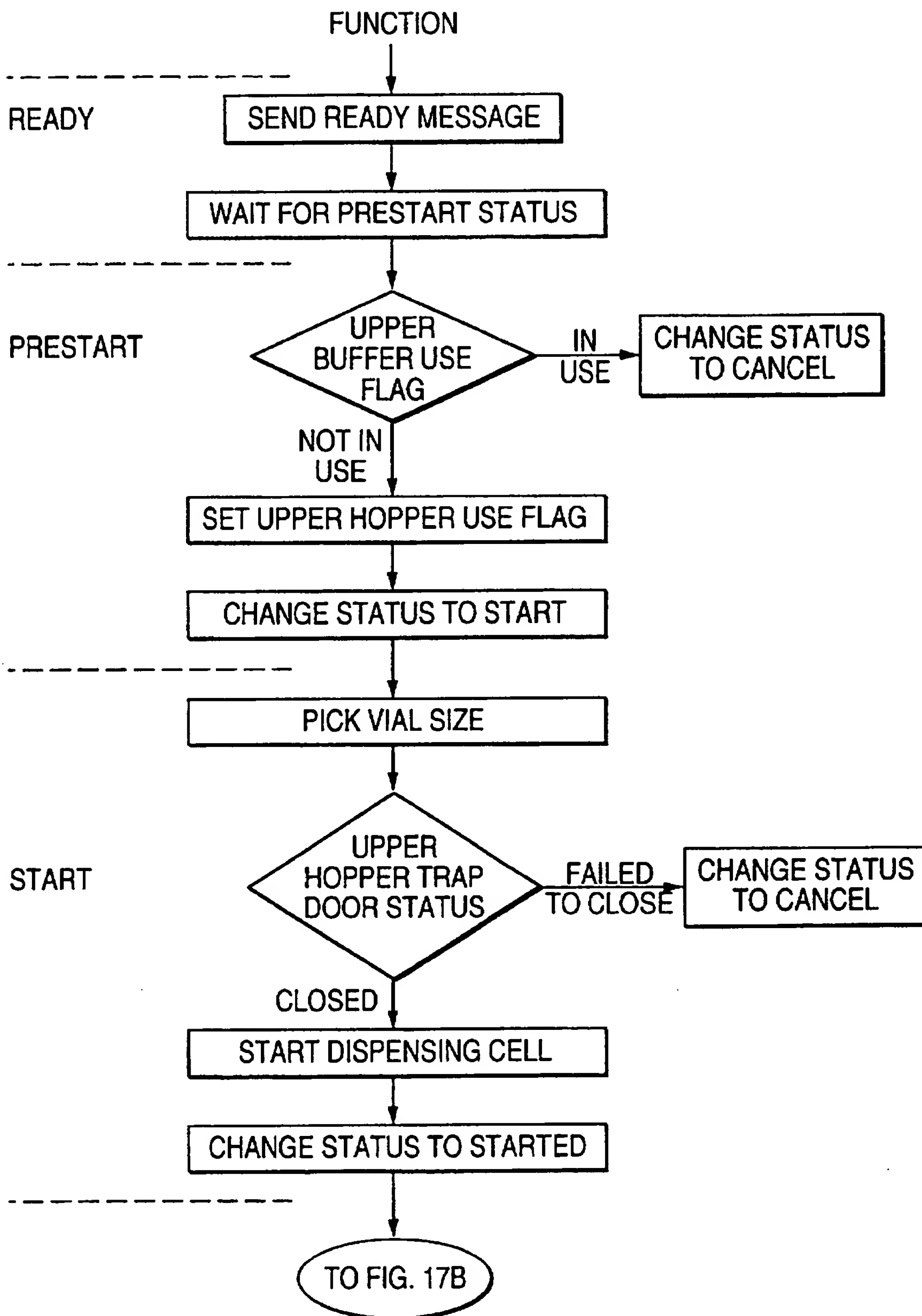
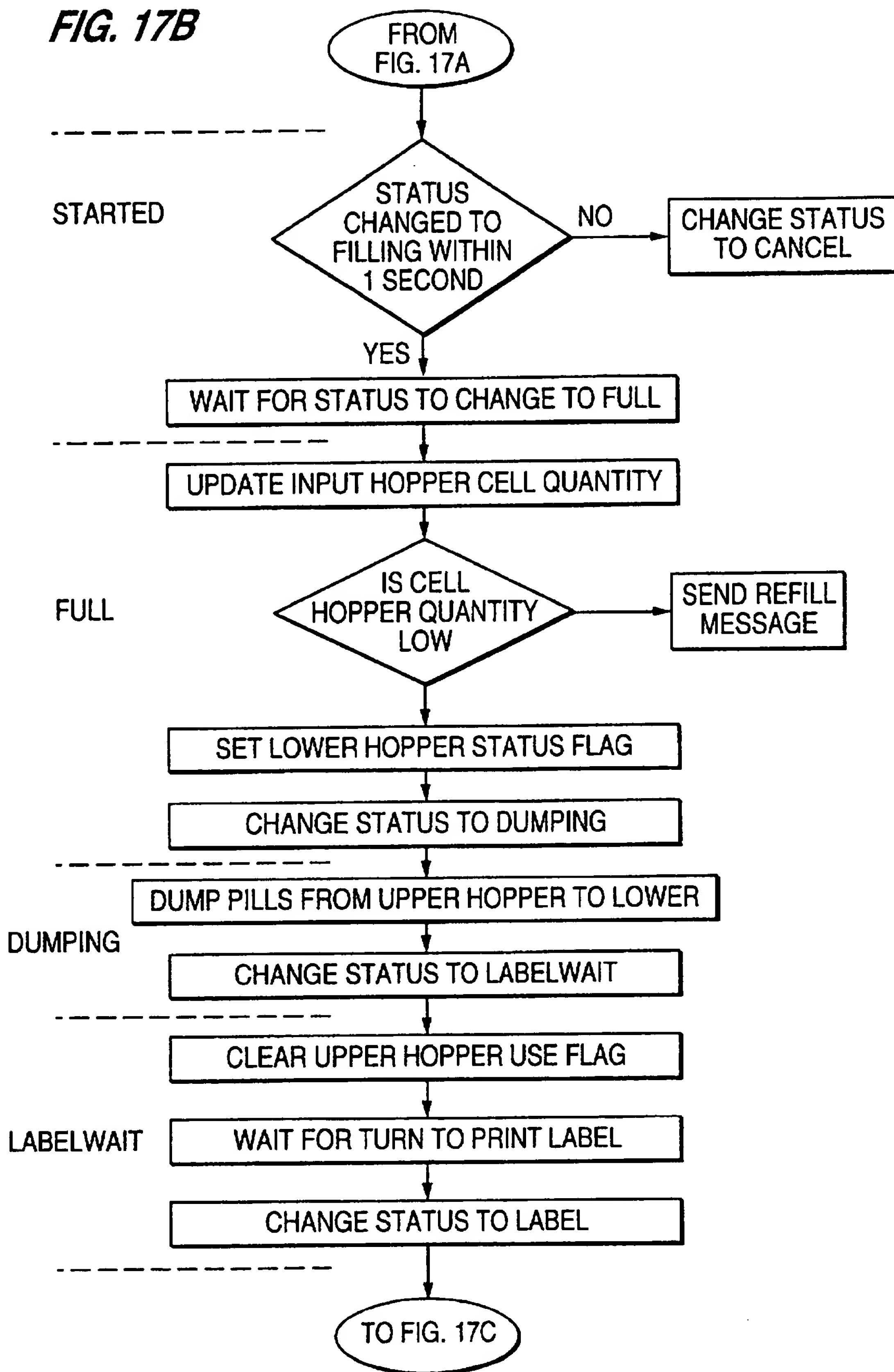
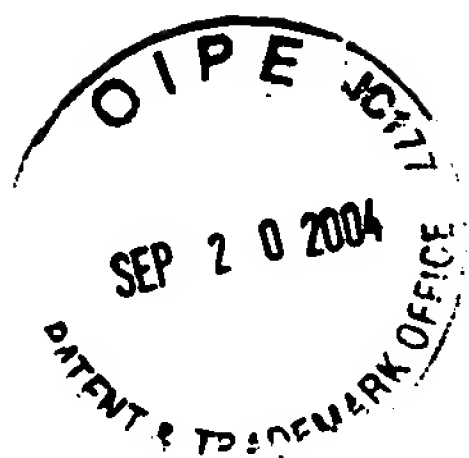
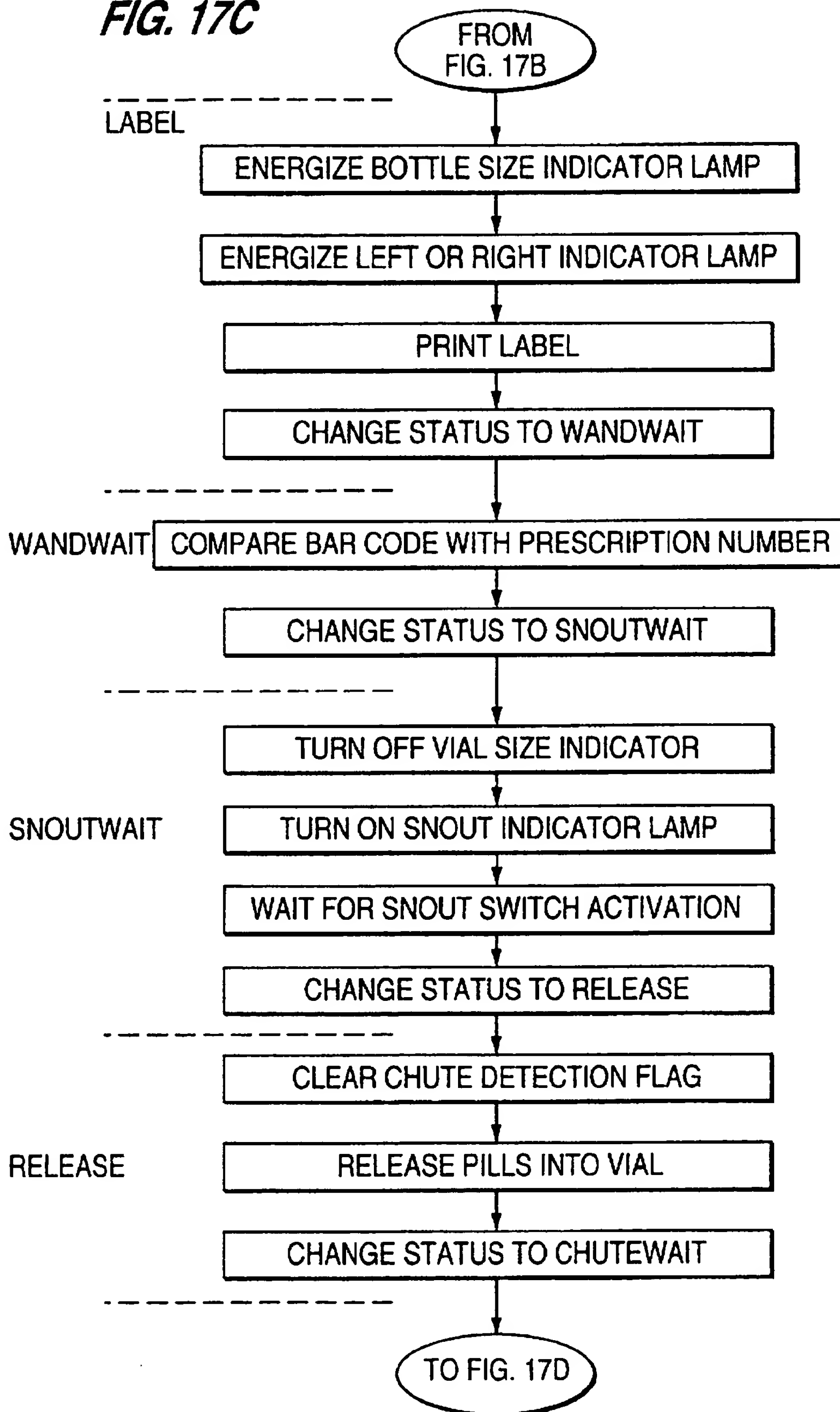


FIG. 17B





**FIG. 17C**







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**FIG. 17D**

